505507380 06/04/2019

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:NEW ASSIGNMENTNATURE OF CONVEYANCE:ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
WOOCHAN KIM	10/04/2018
VIVEK ARORA	10/05/2018
ANINDYA PODDAR	10/04/2018

RECEIVING PARTY DATA

Name:	TEXAS INSTRUMENTS INCORPORATED
Street Address:	12500 TI BLVD.
City:	DALLAS
State/Country:	TEXAS
Postal Code:	75243

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16120922

CORRESPONDENCE DATA

Fax Number: (214)567-2228

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number if provided; if that is unsuccessful, it will be sent via US Mail.

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 214-479-1230 Email: uspto@ti.com

Correspondent Name: TEXAS INSTRUMENTS INCORPORATED

Address Line 1: P O BOX 655474, M/S 3999 Address Line 4: DALLAS, TEXAS 75265

ATTORNEY DOCKET NUMBER: TI-78414

NAME OF SUBMITTER: MARK E. COURTNEY

SIGNATURE: /MARK E. COURTNEY/

DATE SIGNED: 06/04/2019

Total Attachments: 2

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PATENT 505507380 REEL: 049360 FRAME: 0972

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made.

WHEREAS, TEXAS INSTRUMENTS INCORPORATED, a corporation organized and existing under the laws of the State of Delaware, with a place of business at 12500 TI Boulevard, M/S 3999, Dallas, Texas 75243, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon, as well as to U.S. Provisional Application No(s).

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign unto the said TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my entire right, title and interest in and to the said invention and in and to the said application(s) and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Patent and Trademark Office to issue all patents for said invention, or patents resulting therefrom, to the said TEXAS INSTRUMENTS INCORPORATED, as assignee of my entire right, title and interest.

I also hereby sell and assign to TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my corresponding rights to the invention disclosed in said application in all other countries of the world, including the right to claim priority, file applications and obtain patents under the terms of the Paris Convention for the Protection of Industrial Property, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such rights.

I hereby further agree that I will communicate to said TEXAS INSTRUMENTS INCORPORATED, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said TEXAS INSTRUMENTS INCORPORATED, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

I authorize the later insertion of the nonprovisional application number and filing date hereinbelow.

IN WITNESS WHEREOF, I hereunto set hand and seal this day and year;

TITLE	PACKAGED SEMICONDUCTOR DEVICES FOR HIGH VOLTAGE WITH DIE EDGE PROTECTION		
NONPROVISIONAL APPLICATION NO.	16120922	FILING DATE	September 4, 2018

SIGNATURE OF INVENTOR	Jin -
PRINTED NAME OF INVENTOR	Woochan Kim
DATE	10/04/2018
RESIDENCE (CITY AND STATE)	860 Midvale Ln., San Jose, CA 95136

PATENT REEL: 049360 FRAME: 0973

SIGNATURE OF INVENTOR	Lind Der
PRINTED NAME OF INVENTOR	Vivek Arora
DATE	10/05/2018
RESIDENCE (CITY AND STATE)	3604 Warner Drive, San Jose, CA 95127
SIGNATURE OF INVENTOR	Anindye Pollan
PRINTED NAME OF INVENTOR	Anindya Poddar
DATE	19/4/2018
RESIDENCE (CITY AND STATE)	1011 Havre Ct., Sunnyvale, CA 94087

Assignee agrees and accepts the assignment

TEXAS INSTRUMENTS INCORPORATED

After recording, return Assignment to:

Texas Instruments Incorporated PO Box 655474, M/S 3999 Dallas, TX 75265

> PATENT REEL: 049360 FRAME: 0974

RECORDED: 06/04/2019